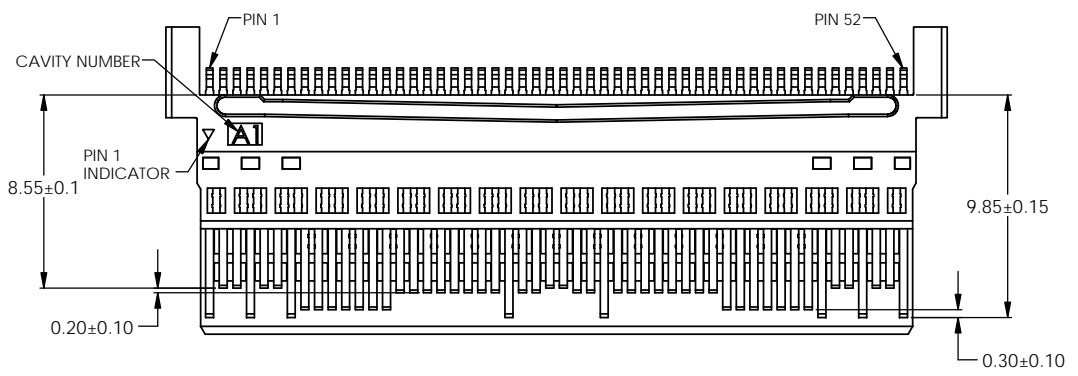
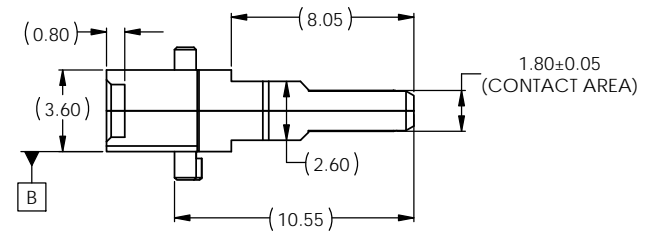
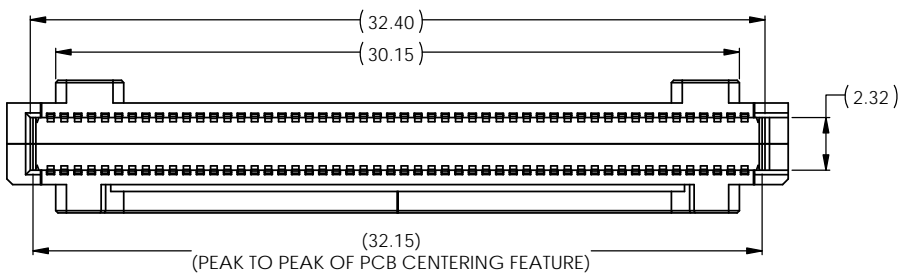
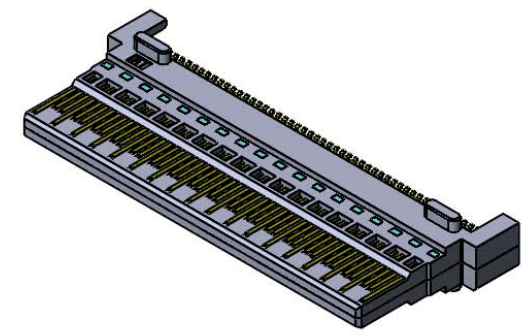
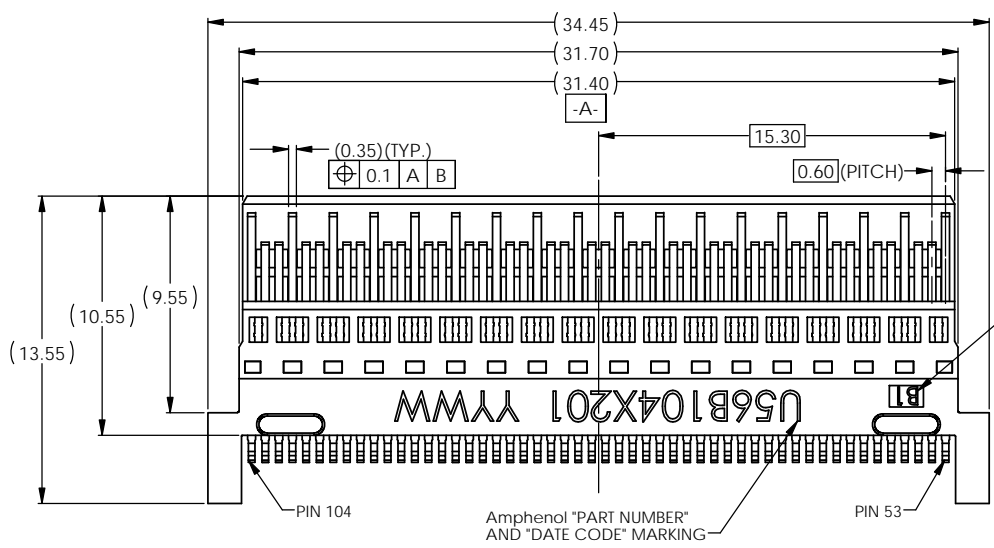


U56 - B104 - X 2 0 1

REVISIONS				
REV	ECN	DESCRIPTION	DATE	APPROVED
-A		PROPOSAL	JAN 03/17	J.S
B		PROPOSAL	MAR 10/17	A.S

- PACKAGING**
TRAY PACKAGING
- OPTION**
2 = FOR 2.1MM THICK PCB SOLDERING
- CONTACT PLATING OPTION**
2 = 30 MICRO INCHES MINIMUM OF GOLD ON MATING END WITH 100 MICRO INCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION, 50 TO 150 MICRO INCHES OF NICKEL UNDER PLATE ALL OVER
3 = 15 MICRO INCHES MINIMUM OF GOLD ON MATING END WITH 100 MICRO INCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION, 50 TO 150 MICRO INCHES OF NICKEL UNDER PLATE ALL OVER



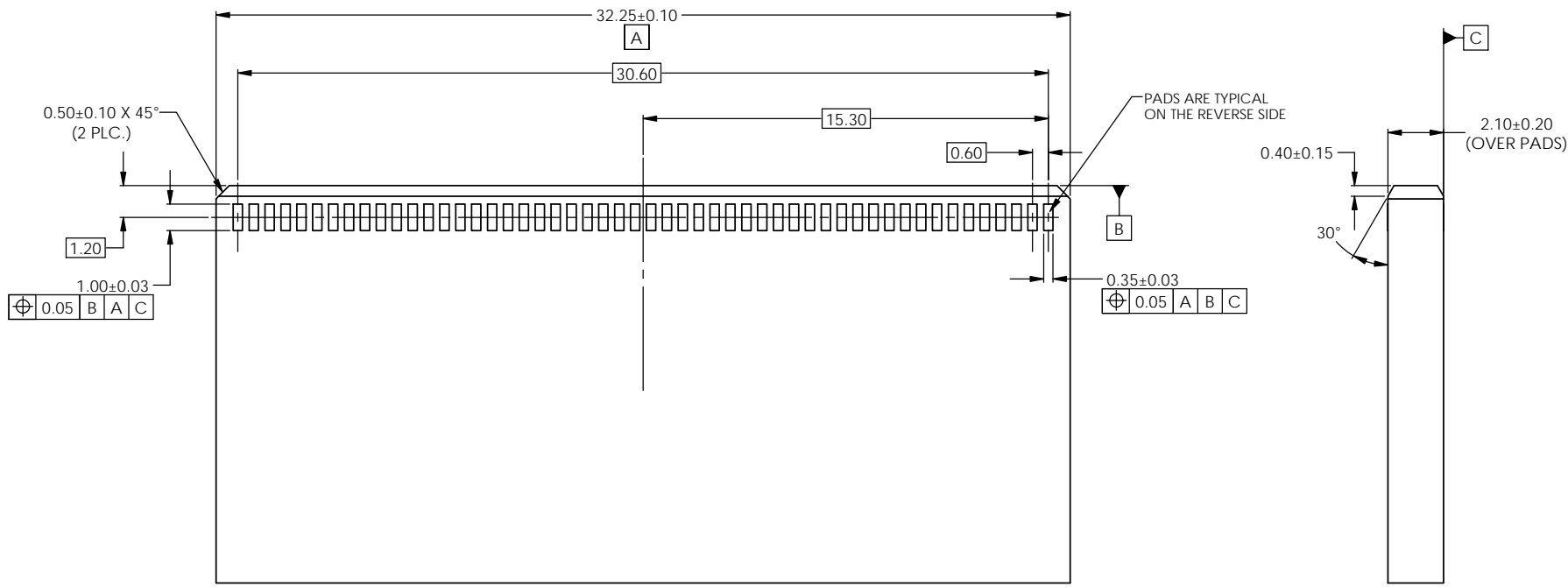
- NOTES:
- MATERIAL:
HOUSING: SOLDER REFLOW PROCESS COMPATIBLE NYLON, UL 94V-0, BLACK
CONTACTS: PHOSPHOR BRONZE
 - TEMPERATURE RANGE: -40°C TO +85°C

DO NOT SCALE DRAWING

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ARE:		APPROVALS		DATE		Amphenol High Speed Interconnects	
DIGITALS	ANGLES	DRAWN	HISEN.X	JAN 03/17	FILE		
.X ± 0.20	± 2°	DESIGNED	HISEN.X	DEC 23/16	PROJECT	CFP2 PLUG CONNECTOR FOR 2.1mm THICK PCB SOLDERING	
.XX ± 0.10		CHECKED	A.S	JAN 03/17	SCALE	6:1	
MATERIAL AND FINISH		DR. APP'D			PROJECT	U56	
ENG. REL. NO.		ENG. APP'D	J.SI	JAN 03/17	DWG. NO.	P-U56-B104-X201	REV. B
CODE IDENT. NO.	03554	DWG. APP'D	J.SI	JAN 03/17	SHEET	1 OF 2	

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REVISIONS				
REV	ECN	DESCRIPTION	DATE	APPROVED
A		PROPOSAL	JAN 03/17	J.S
B		PROPOSAL	MAR 10/17	A.S



REAR PCB LAYOUT

DO NOT SCALE DRAWING

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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS		APPROVALS		DATE		Amphenol High Speed Interconnects	
DRAWN	HISEN.X	JAN 03/17	DESIGNED	HISEN.X	DEC 23/16	CFP2 PLUG CONNECTOR FOR 2.1mm THICK PCB SOLDERING	
CHECKED	A.S	JAN 03/17	MATERIAL AND FINISH				
ENG. REL. NO.	E. APPD		SCALE	6:1	PROJECT	U56	SHEET 2 OF 2
CODE IDENT. NO.	03554	ENG. APPD	J.S	JAN 03/17	DWG. NO.	P-U56-B104-X201	REV. B